PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kenichi ASAMIZU	07/20/2010

RECEIVING PARTY DATA

Name:	HONDA MOTOR CO., LTD.		
Street Address:	1-1, Minami-Aoyama 2-chome		
City:	Minato-ku, Tokyo		
State/Country:	JAPAN		
Postal Code:	107-8556		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12933795

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 027596.00115

NAME OF SUBMITTER: Charles M. Marmelstein

Total Attachments: 1

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OP \$40,00

PATENT REEL: 025065 FRAME: 0962

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U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventors (hereinafter ASSIGNOR) by

•	osnoration para to the andersigned inven	tors (neremarker 74551G(VOR) by				
[Insert ASSIGNEE's	HONDA MOTOR CO., LTD.					
Name(s)	(s) Minato-ku, Tokyo, 107-8556 Japan (hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest, including the right to sue for past infringement, if any, and all rights pursuant to 35 U.S.C. §154, to the invention entitled WORK MOUNTING SYSTEM AND METHOD OF MOUNTING WORK					
(()						
[Title of Invention]						
[*If the assignment is being filed after the filing of the application, this section must be completed]	for which application for Letters Patent of the United States was filed on, and assigned Serial No.12/933,795 (Arent Fox PLLC is hereby authorized to insert the series code, serial number and/or filing date hereon, when known) and all Letters Patent of the United States to be obtained therefor on said application or any continuation, divisional, renewal, substitute, reissue or reexamination thereof, and any other application claiming priority thereto, for the full term or terms for which the same may be granted.					
	The ASSIGNOR agrees to execute continuing, divisional, reissue or reexami assignments in connection with such applica	nation applications thereof and	also to execute separate			
	The ASSIGNOR agrees to execute litigation, or other legal proceeding which continuation, division, reissue or reexaminate and to cooperate with the ASSIGNEE in exproceeding with such interference, litigation,	ch may be declared concerning ion thereof or Letters Patent or re- very way possible in obtaining as	g this application or any sissue patent issued thereon			
	IN WITNESS WHEREOF, the undersigned	inventors have affixed their signa	tures.			
Signature(s) of Assignor(s)]	Kenichi Bamy	Kenichi ASAMIZU (TYPE NAME)	Ju(y 20, 20/0 (DATE)			
	(SIGNATURE)	(TYPE NAME)	(DATE)			
	(SIGNATURE)	(TYPE NAME)	(DATE)			
	(SIGNATURE)	(TYPE NAME)	(DATE)			
	(SIGNATURE)	(TYPE NAME)	(DATE)			

NO LEGALIZATION REQUIRED

RECORDED: 09/30/2010

PATENT REEL: 025065 FRAME: 0963